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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/586,908	07/24/2006	Akihiro Goto	1032404-000154	1812
	7590 11/25/200 INGERSOLL & ROOI	EXAMINER		
POST OFFICE	BOX 1404	DOAN, NGHIA M		
ALEAANDKIA	A, VA 22313-1404	ART UNIT	PAPER NUMBER	
		2825		
			NOTIFICATION DATE	DELIVERY MODE
			11/25/2009	ELECTRONIC

## Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

ADIPFDD@bipc.com

## Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s)	
10/586,908	GOTO ET AL.	
Examiner	Art Unit	
NGHIA M. DOAN	2825	

	NGHIA M. DOAN	2825						
The MAILING DATE of this communication appe	ars on the cover sheet with the c	correspondence add	ress					
THE REPLY FILED <u>16 November 2009</u> FAILS TO PLACE THIS	APPLICATION IN CONDITION F	OR ALLOWANCE.						
. Mathematical The reply was filed after a final rejection, but prior to or on the same day as filing a Notice of Appeal. To avoid abandonment of this application, applicant must timely file one of the following replies: (1) an amendment, affidavit, or other evidence, which places the application in condition for allowance; (2) a Notice of Appeal (with appeal fee) in compliance with 37 CFR 41.31; or (3) a Request for Continued Examination (RCE) in compliance with 37 CFR 1.114. The reply must be filed within one of the following time periods:								
a) The period for reply expires <u>0</u> months from the mailing date	e of the final rejection.							
b) The period for reply expires on: (1) the mailing date of this A no event, however, will the statutory period for reply expire to Examiner Note: If box 1 is checked, check either box (a) or (MONTHS OF THE FINAL REJECTION. See MPEP 706.07(for the first section of the first section	ater than SIX MONTHS from the mailing b). ONLY CHECK BOX (b) WHEN THE j).	date of the final rejection FIRST REPLY WAS FII	n. LED WITHIN TWO					
Extensions of time may be obtained under 37 CFR 1.136(a). The date of have been filed is the date for purposes of determining the period of extunder 37 CFR 1.17(a) is calculated from: (1) the expiration date of the sign forth in (b) above, if checked. Any reply received by the Office later may reduce any earned patent term adjustment. See 37 CFR 1.704(b). NOTICE OF APPEAL	ension and the corresponding amount of hortened statutory period for reply origin	of the fee. The appropria nally set in the final Office	ate extension fee e action; or (2) as					
2. ☐ The Notice of Appeal was filed on A brief in comp	liance with 37 CFR 41.37 must be f	iled within two months	s of the date of					
filing the Notice of Appeal (37 CFR 41.37(a)), or any exter Notice of Appeal has been filed, any reply must be filed wi	nsion thereof (37 CFR 41.37(e)), to	avoid dismissal of the						
AMENDMENTS	out uniques the data of films a build	udli mot ha ontonod ha						
<ol> <li>The proposed amendment(s) filed after a final rejection, k</li> <li>They raise new issues that would require further cor</li> <li>They raise the issue of new matter (see NOTE belowed)</li> </ol>	nsideration and/or search (see NOT		cause					
(c) They are not deemed to place the application in bett appeal; and/or	·	lucing or simplifying tl	ne issues for					
(d) $igsqcup$ They present additional claims without canceling a $lpha$	corresponding number of finally reje	ected claims.						
NOTE: (See 37 CFR 1.116 and 41.33(a)).								
4. The amendments are not in compliance with 37 CFR 1.12		mpliant Amendment (I	PTOL-324).					
<ul><li>5. Applicant's reply has overcome the following rejection(s):</li><li>6. Newly proposed or amended claim(s) would be all</li></ul>		imely filed amendmer	ot canceling the					
non-allowable claim(s).	owabie ii submitted iii a separate, t	illiely filed afficilation	it canceling the					
7. For purposes of appeal, the proposed amendment(s): a) will not be entered, or b) will be entered and an expl how the new or amended claims would be rejected is provided below or appended.  The status of the claim(s) is (or will be) as follows:  Claim(s) allowed:  Claim(s) objected to:								
Claim(s) rejected: <u>11-20</u> . Claim(s) withdrawn from consideration:								
AFFIDAVIT OR OTHER EVIDENCE								
<ol> <li>The affidavit or other evidence filed after a final action, but because applicant failed to provide a showing of good and was not earlier presented. See 37 CFR 1.116(e).</li> </ol>								
9. The affidavit or other evidence filed after the date of filing entered because the affidavit or other evidence failed to o showing a good and sufficient reasons why it is necessary	vercome <u>all</u> rejections under appea	l and/or appellant fail:	s to provide a					
10.   The affidavit or other evidence is entered. An explanation	•							
REQUEST FOR RECONSIDERATION/OTHER  11. ☑ The request for reconsideration has been consider because:  See Continuation Sheet.	ered but does NOT place the applic	ation in condition for a	allowance					
12. Note the attached Information Disclosure Statement(s). (	PTO/SB/08) Paper No(s)							
13.  Other:								
/Jack Chiang/ Supervisory Patent Examiner, Art Unit 2825								

Continuation of 11. does NOT place the application in condition for allowance because: Applicant's arguments filed 11/16/2009 have been fully considered but they are not persuasive. Therefore, the claim rejection is sustained as the following reasons:

First, Yamazaki's figure 3, show a semiconductor device having at least variation position, wiring length, and wiring spacing. Abe's figures 10-11 and 13-14 shown a mask (image) pattern of semiconductor device having an offset (variation) position and furthermore, Abe's reference provides an apparatus as shown in figures 1-2 to perform packaging (die bonder) a semiconductor device which may have offset (variation) position (see Abe's figures 10-11 and 13-14). In the combination Yamazaki and Abe (or even figure 3 itself of Yamazaki) may carry out the apparatus to support for designing a semiconductor device that achieves the purpose of the instant Application's claimed invention.

Second, in response to applicant's arguments against the references individually (in this case, Abe's reference), one cannot show nonobviousness by attacking references individually where the rejections are based on combinations of references (Yamazaki and Abe references). See In re Keller, 642 F.2d 413, 208 USPQ 871 (CCPA 1981); In re Merck & Co., 800 F.2d 1091, 231 USPQ 375 (Fed. Cir. 1986).

As those reasons above, the claim rejection is sustained.